PRODUCTS AFFECTED: SP4082EEN-L
SP4082EEN-L/TR

CHANGE CATEGORY:

☐ Material  ☐ Process  ☐ Package
☐ Design  ☐ Datasheet  ☐ Packing/Shipping
☒ Other: Alternate Foundry and Assembly Site

DESCRIPTION OF CHANGE:
1. Qualification of an alternate foundry site, TSMC.
2. Qualification of alternate assembly sites, Carsem, Ipoh, Malaysia and ASE, Chung-Li, Taiwan using copper or gold wire bonding.

IMPACT OF CHANGE:
There is no change to product form, fit or function.

TARGET IMPLEMENTATION DATE: 24-JULY-2015

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data